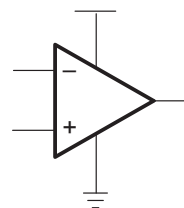


# TLV2401, TLV2402, TLV2404 FAMILY OF 880-nA/Ch RAIL-TO-RAIL INPUT/OUTPUT OPERATIONAL AMPLIFIERS WITH REVERSE BATTERY PROTECTION

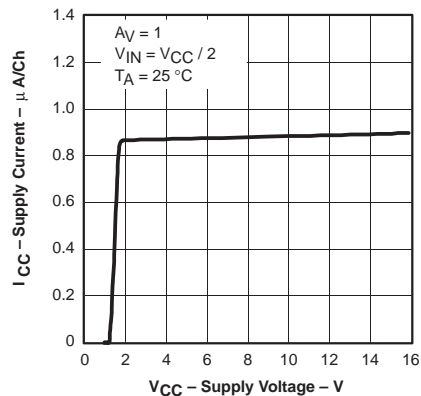
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- **Micro-Power Operation . . . < 1  $\mu$ A/Channel**
- **Input Common-Mode Range Exceeds the Rails . . . -0.1 V to  $V_{CC} + 5$  V**
- **Reverse Battery Protection Up To 18 V**
- **Rail-to-Rail Input/Output**
- **Gain Bandwidth Product . . . 5.5 kHz**
- **Supply Voltage Range . . . 2.5 V to 16 V**
- **Specified Temperature Range**
  - $T_A = 0^\circ\text{C}$  to  $70^\circ\text{C}$  . . . Commercial Grade
  - $T_A = -40^\circ\text{C}$  to  $125^\circ\text{C}$  . . . Industrial Grade
- **Ultrasmall Packaging**
  - 5-Pin SOT-23 (TLV2401)
  - 8-Pin MSOP (TLV2402)
- **Universal OpAmp EVM (Refer to the EVM Selection Guide SLOU060)**

Operational Amplifier



**SUPPLY CURRENT  
vs  
SUPPLY VOLTAGE**



## description

The TLV240x family of single-supply operational amplifiers has the lowest supply current available today at only 880 nA per channel. Reverse battery protection guards the amplifier from an over-current condition due to improper battery installation. For harsh environments, the inputs can be taken 5 V above the positive supply rail without damage to the device.

The low supply current is coupled with extremely low input bias currents enabling them to be used with mega- $\Omega$  resistors making them ideal for portable, long active life, applications. DC accuracy is ensured with a low typical offset voltage as low as 390  $\mu$ V, CMRR of 120 dB and minimum open loop gain of 130 V/mV at 2.7 V.

The maximum recommended supply voltage is as high as 16 V and ensured operation down to 2.5 V, with electrical characteristics specified at 2.7 V, 5 V and 15 V. The 2.5-V operation makes it compatible with Li-Ion battery-powered systems and many micro-power microcontrollers available today including TI's MSP430.

All members are available in PDIP and SOIC with the singles in the small SOT-23 package, duals in the MSOP, and quads in TSSOP.

### SELECTION OF SINGLE SUPPLY OPERATIONAL AMPLIFIER PRODUCTS†

| DEVICE   | $V_{CC}$<br>(V) | $V_{IO}$<br>(mV) | BW<br>(MHz) | SLEW RATE<br>(V/ $\mu$ s) | $I_{CC}/ch$<br>( $\mu$ A) | RAIL-TO-RAIL |
|----------|-----------------|------------------|-------------|---------------------------|---------------------------|--------------|
| TLV240x‡ | 2.5–16          | 0.390            | 0.005       | 0.002                     | 0.880                     | I/O          |
| TLV224x  | 2.5–12          | 0.600            | 0.005       | 0.002                     | 1                         | I/O          |
| TLV2211  | 2.7–10          | 0.450            | 0.065       | 0.025                     | 13                        | O            |
| TLV245x  | 2.7–6           | 0.020            | 0.22        | 0.110                     | 23                        | I/O          |
| TLV225x  | 2.7–8           | 0.200            | 0.2         | 0.12                      | 35                        | O            |

† All specifications are typical values measured at 5 V.

‡ This device also offers 18-V reverse battery protection and 5-V over-the-rail operation on the inputs.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

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# TLV2401, TLV2402, TLV2404

## FAMILY OF 880-nA/Ch RAIL-TO-RAIL INPUT/OUTPUT

### OPERATIONAL AMPLIFIERS WITH REVERSE BATTERY PROTECTION

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#### TLV2401 AVAILABLE OPTIONS

| T <sub>A</sub> | V <sub>IOmax</sub><br>AT 25°C | PACKAGED DEVICES      |                  |         |                    |
|----------------|-------------------------------|-----------------------|------------------|---------|--------------------|
|                |                               | SMALL OUTLINE†<br>(D) | SOT-23†<br>(DBV) | SYMBOLS | PLASTIC DIP<br>(P) |
| 0°C to 70°C    | 1500 μV                       | TLV2401CD             | TLV2401CDBV      | VAWC    | —                  |
| -40°C to 125°C |                               | TLV2401ID             | TLV2401IDBV      | VAWI    | TLV2401IP          |

† This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLV2401CDR).

#### TLV2402 AVAILABLE OPTIONS

| T <sub>A</sub> | V <sub>IOmax</sub><br>AT 25°C | PACKAGED DEVICES      |                |         |                    |
|----------------|-------------------------------|-----------------------|----------------|---------|--------------------|
|                |                               | SMALL OUTLINE†<br>(D) | MSOP†<br>(DGK) | SYMBOLS | PLASTIC DIP<br>(P) |
| 0°C to 70°C    | 1500 μV                       | TLV2402CD             | TLV2402CDGK    | xxTIAIX | —                  |
| -40°C to 125°C |                               | TLV2402ID             | TLV2402IDGK    | xxTIAIY | TLV2402IP          |

† This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLV2402CDR).

#### TLV2404 AVAILABLE OPTIONS

| T <sub>A</sub> | V <sub>IOmax</sub><br>AT 25°C | PACKAGED DEVICES      |                    |               |
|----------------|-------------------------------|-----------------------|--------------------|---------------|
|                |                               | SMALL OUTLINE†<br>(D) | PLASTIC DIP<br>(N) | TSSOP<br>(PW) |
| 0°C to 70°C    | 1500 μV                       | TLV2404CD             | TLV2404CN          | TLV2404CPW    |
| -40°C to 125°C |                               | TLV2404ID             | TLV2404IN          | TLV2404IPW    |

† This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLV2404CDR).

### TLV240x PACKAGE PINOUTS



NC – No internal connection

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**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†**

|  |                              |
|--|------------------------------|
| Supply voltage, $V_{CC}$ (see Note 1)                        | 17 V                         |
| Differential input voltage range, $V_{ID}$                   | $\pm 20$ V                   |
| Input current range, $I_I$ (any input)                       | $\pm 10$ mA                  |
| Output current range, $I_O$                                  | $\pm 10$ mA                  |
| Continuous total power dissipation                           | See Dissipation Rating Table |
| Operating free-air temperature range, $T_A$ : C suffix       | 0°C to 70°C                  |
| I suffix   | -40°C to 125°C               |
| Maximum junction temperature, $T_J$                          | 150°C                        |
| Storage temperature range, $T_{stg}$                         | -65°C to 150°C               |
| Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds | 260°C                        |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values, except differential voltages, are with respect to GND

**DISSIPATION RATING TABLE**

| PACKAGE | $\Theta_{JC}$<br>(°C/W) | $\Theta_{JA}$<br>(°C/W) | $T_A \leq 25^\circ\text{C}$<br>POWER RATING | $T_A = 125^\circ\text{C}$<br>POWER RATING |
|---------|-------------------------|-------------------------|---|---|
| D (8)   | 38.3                    | 176                     | 710 mW                                      | 142 mW                                    |
| D (14)  | 26.9                    | 122.6                   | 1022 mW                                     | 204.4 mW                                  |
| DBV (5) | 55                      | 324.1                   | 385 mW                                      | 77.1 mW                                   |
| DGK (8) | 54.2                    | 259.9                   | 481 mW                                      | 96.2 mW                                   |
| N (14)  | 32                      | 78                      | 1600 mW                                     | 320.5 mW                                  |
| P (8)   | 41                      | 104                     | 1200 mW                                     | 240.4 mW                                  |
| PW (14) | 29.3                    | 173.6                   | 720 mW                                      | 144 mW                                    |

**recommended operating conditions**

|  |               | MIN        | MAX        | UNIT |
|--|---------------|------------|------------|------|
| Supply voltage, $V_{CC}$                   | Single supply | 2.5        | 16         | V    |
|  | Split supply  | $\pm 1.25$ | $\pm 8$    |      |
| Common-mode input voltage range, $V_{ICR}$ |               | -0.1       | $V_{CC}+5$ | V    |
| Operating free-air temperature, $T_A$      | C-suffix      | 0          | 70         | °C   |
|  | I-suffix      | -40        | 125        |      |



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**electrical characteristics at recommended operating conditions,  $V_{CC} = 2.7, 5 \text{ V}$ , and  $15 \text{ V}$  (unless otherwise noted)**

**dc performance**

| PARAMETER       |   | TEST CONDITIONS  | $T_A^\dagger$   | MIN        | TYP  | MAX  | UNIT                         |
|-----------------|---|--|---|------------|------|------|------------------------------|
| $V_{IO}$        | Input offset voltage                            | $V_O = V_{CC}/2 \text{ V}$ ,<br>$V_{IC} = V_{CC}/2 \text{ V}$ ,<br>$R_S = 50 \Omega$ | 25°C  | 390        | 1200 |      | $\mu\text{V}$                |
|                 |   |  | Full range  |            | 1500 |      |                              |
| $\alpha V_{IO}$ | Offset voltage draft                            |  | 25°C  | 3          |      |      | $\mu\text{V}/^\circ\text{C}$ |
| CMRR            | Common-mode rejection ratio                     | $V_{IC} = 0 \text{ to } V_{CC}$ ,<br>$R_S = 50 \Omega$                               | $V_{CC} = 2.7 \text{ V}$  | 25°C       | 63   | 120  | dB                           |
|                 |   |  |   | Full range | 60   |      |                              |
|                 |   |  | $V_{CC} = 5 \text{ V}$  | 25°C       | 70   | 120  |                              |
|                 |   |  |   | Full range | 63   |      |                              |
|                 |   |  | $V_{CC} = 15 \text{ V}$   | 25°C       | 80   | 120  |                              |
|                 |   |  |   | Full range | 75   |      |                              |
| AVD             | Large-signal differential voltage amplification | $V_{CC} = 2.7 \text{ V}$ , $V_{O(pp)} = 1 \text{ V}$ , $R_L = 500 \text{ k}\Omega$   | 25°C  | 130        | 400  | V/mV |                              |
|                 |   |  | Full range  | 30         |      |      |                              |
|                 |   |  | $V_{CC} = 5 \text{ V}$ , $V_{O(pp)} = 3 \text{ V}$ , $R_L = 500 \text{ k}\Omega$  | 25°C       | 300  |      | 1000                         |
|                 |   |  |   | Full range | 100  |      |                              |
|                 |   |  | $V_{CC} = 15 \text{ V}$ , $V_{O(pp)} = 6 \text{ V}$ , $R_L = 500 \text{ k}\Omega$ | 25°C       | 1000 |      | 1800                         |
|                 |   |  |   | Full range | 120  |      |                              |

$^\dagger$  Full range is 0°C to 70°C for the C suffix and -40°C to 125°C for the I suffix. If not specified, full range is -40°C to 125°C.

**input characteristics**

| PARAMETER  |                               | TEST CONDITIONS  | $T_A^\dagger$ | MIN      | TYP | MAX              | UNIT |  |
|------------|-------------------------------|--|---------------|----------|-----|------------------|------|--|
| $I_{IO}$   | Input offset current          | $V_O = V_{CC}/2 \text{ V}$ ,<br>$V_{IC} = V_{CC}/2 \text{ V}$ ,<br>$R_S = 50 \Omega$ | 25°C          | 25       | 250 |                  | pA   |  |
|            |                               |  | Full range    | TLV240xC |     | 300              |      |  |
|            |                               |  |               | TLV240xI |     | 400              |      |  |
| $I_{IB}$   | Input bias current            | $V_O = V_{CC}/2 \text{ V}$ ,<br>$V_{IC} = V_{CC}/2 \text{ V}$ ,<br>$R_S = 50 \Omega$ | 25°C          | 100      | 300 |                  | pA   |  |
|            |                               |  | Full range    | TLV240xC |     | 350              |      |  |
|            |                               |  |               | TLV240xI |     | 900              |      |  |
| $r_{i(d)}$ | Differential input resistance |  | 25°C          | 300      |     | $\text{M}\Omega$ |      |  |
| $C_{i(c)}$ | Common-mode input capacitance | $f = 100 \text{ kHz}$  | 25°C          | 3        |     | pF               |      |  |

$^\dagger$  Full range is 0°C to 70°C for the C suffix and -40°C to 125°C for the I suffix. If not specified, full range is -40°C to 125°C.



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electrical characteristics at recommended operating conditions,  $V_{CC} = 2.7, 5 \text{ V}$ , and  $15 \text{ V}$  (unless otherwise noted) (continued)

**output characteristics**

| PARAMETER                          | TEST CONDITIONS                                     | $T_A$ †                  | MIN        | TYP       | MAX   | UNIT          |
|------------------------------------|---|--------------------------|------------|-----------|-------|---------------|
| $V_{OH}$ High-level output voltage | $V_{IC} = V_{CC}/2$ ,<br>$I_{OH} = -2 \mu\text{A}$  | $V_{CC} = 2.7 \text{ V}$ | 25°C       | 2.65      | 2.68  | V             |
|                                    |   |                          | Full range | 2.63      |       |               |
|                                    |   | $V_{CC} = 5 \text{ V}$   | 25°C       | 4.95      | 4.98  |               |
|                                    |   |                          | Full range | 4.93      |       |               |
|                                    |   | $V_{CC} = 15 \text{ V}$  | 25°C       | 14.95     | 14.98 |               |
|                                    |   |                          | Full range | 14.93     |       |               |
|                                    | $V_{IC} = V_{CC}/2$ ,<br>$I_{OH} = -50 \mu\text{A}$ | $V_{CC} = 2.7 \text{ V}$ | 25°C       | 2.62      | 2.65  |               |
|                                    |   |                          | Full range | 2.6       |       |               |
|                                    |   | $V_{CC} = 5 \text{ V}$   | 25°C       | 4.92      | 4.95  |               |
|                                    |   |                          | Full range | 4.9       |       |               |
|                                    |   | $V_{CC} = 15 \text{ V}$  | 25°C       | 14.92     | 14.95 |               |
|                                    |   |                          | Full range | 14.9      |       |               |
| $V_{OL}$ Low-level output voltage  | $V_{IC} = V_{CC}/2$ , $I_{OL} = 2 \mu\text{A}$      | 25°C                     |            | 90        | 150   | mV            |
|                                    |   | Full range               |            |           | 180   |               |
|                                    | $V_{IC} = V_{CC}/2$ , $I_{OL} = 50 \mu\text{A}$     | 25°C                     |            | 180       | 230   |               |
|                                    |   | Full range               |            |           | 260   |               |
| $I_O$ Output current               | $V_O = 0.5 \text{ V}$ from rail                     | 25°C                     |            | $\pm 200$ |       | $\mu\text{A}$ |

† Full range is 0°C to 70°C for the C suffix and -40°C to 125°C for the I suffix. If not specified, full range is -40°C to 125°C.

**power supply**

| PARAMETER  | TEST CONDITIONS  | $T_A$ †                                   | MIN        | TYP | MAX  | UNIT |
|--|--|---|------------|-----|------|------|
| $I_{CC}$ Supply current (per channel)                                  | $V_O = V_{CC}/2$   | $V_{CC} = 2.7 \text{ V}$ or $5 \text{ V}$ | 25°C       | 880 | 950  | nA   |
|  |  |   | Full range |     | 1290 |      |
|  |  | $V_{CC} = 15 \text{ V}$                   | 25°C       | 900 | 990  |      |
|  |  |   | Full range |     | 1350 |      |
| Reverse supply current   | $V_{CC} = -18 \text{ V}$ , $V_{IN} = 0 \text{ V}$ ,<br>$V_O = \text{Open circuit}$ | 25°C                                      |            | 50  |      | nA   |
| PSRR Power supply rejection ratio<br>( $\Delta V_{CC}/\Delta V_{IO}$ ) | $V_{CC} = 2.7$ to $5 \text{ V}$ ,<br>$V_{IC} = V_{CC}/2 \text{ V}$ ,<br>No load,   | TLV240xC                                  | 25°C       | 100 | 120  | dB   |
|  |  |   | Full range | 96  |      |      |
|  |  | TLV240xI                                  | 25°C       | 85  |      | dB   |
|  |  |   | Full range | 85  |      |      |
|  | $V_{CC} = 5$ to $15 \text{ V}$ , $V_{IC} = V_{CC}/2 \text{ V}$ ,<br>No load        | 25°C                                      | 100        | 120 | dB   |      |
|  |  | Full range                                | 100        |     |      |      |

† Full range is 0°C to 70°C for the C suffix and -40°C to 125°C for the I suffix. If not specified, full range is -40°C to 125°C.



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**electrical characteristics at recommended operating conditions,  $V_{CC} = 2.7, 5 \text{ V}$ , and  $15 \text{ V}$  (unless otherwise noted) (continued)**

**dynamic performance**

| PARAMETER |                         | TEST CONDITIONS  |  | $T_A$              | MIN   | TYP | MAX | UNIT |
|-----------|-------------------------|--|--|--------------------|-------|-----|-----|------|
| UGBW      | Unity gain bandwidth    | $R_L = 500 \text{ k}\Omega$ ,  | $C_L = 100 \text{ pF}$                               | $25^\circ\text{C}$ |       | 5.5 |     | kHz  |
| SR        | Slew rate at unity gain | $V_{O(pp)} = 0.8 \text{ V}$ ,  | $R_L = 500 \text{ k}\Omega$ , $C_L = 100 \text{ pF}$ | $25^\circ\text{C}$ |       | 2.5 |     | V/ms |
| $\phi M$  | Phase margin            | $R_L = 500 \text{ k}\Omega$ , $C_L = 100 \text{ pF}$   |  | $25^\circ\text{C}$ | 60°   |     |     |      |
|           | Gain margin             |  |  |                    | 15    |     |     | dB   |
| $t_s$     | Settling time           | $V_{CC} = 2.7 \text{ or } 5 \text{ V}$ ,<br>$V(\text{STEP})_{PP} = 1 \text{ V}$ , $C_L = 100 \text{ pF}$ ,<br>$A_V = -1$ , $R_L = 100 \text{ k}\Omega$ |  | $25^\circ\text{C}$ | 0.1%  |     |     | ms   |
|           |                         | $V_{CC} = 15 \text{ V}$ ,<br>$V(\text{STEP})_{PP} = 1 \text{ V}$ , $C_L = 100 \text{ pF}$ ,<br>$A_V = -1$ , $R_L = 100 \text{ k}\Omega$                |  |                    | 0.1%  |     |     |      |
|           |                         | $V_{CC} = 15 \text{ V}$ ,<br>$V(\text{STEP})_{PP} = 1 \text{ V}$ , $C_L = 100 \text{ pF}$ ,<br>$A_V = -1$ , $R_L = 100 \text{ k}\Omega$                |  |                    | 0.01% |     |     |      |

**noise/distortion performance**

| PARAMETER |                                | TEST CONDITIONS      | $T_A$              | MIN | TYP | MAX | UNIT                         |
|-----------|--------------------------------|----------------------|--------------------|-----|-----|-----|------------------------------|
| $V_n$     | Equivalent input noise voltage | $f = 10 \text{ Hz}$  | $25^\circ\text{C}$ | 800 |     |     | $\text{nV}/\sqrt{\text{Hz}}$ |
|           |                                | $f = 100 \text{ Hz}$ |                    | 500 |     |     |                              |
| $I_n$     | Equivalent input noise current | $f = 100 \text{ Hz}$ |                    | 8   |     |     | $\text{fA}/\sqrt{\text{Hz}}$ |



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**TYPICAL CHARACTERISTICS**

**Table of Graphs**

|             |                                       |                              | <b>FIGURE</b> |
|-------------|---------------------------------------|------------------------------|---------------|
| $V_{IO}$    | Input Offset Voltage                  | vs Common-mode input voltage | 1, 2, 3       |
| $I_{IB}$    | Input Bias Current                    | vs Free-air temperature      | 4, 6, 8       |
|             |                                       | vs Common-mode input voltage | 5, 7, 9       |
| $I_{IO}$    | Input Offset Current                  | vs Free-air temperature      | 4, 6, 8       |
|             |                                       | vs Common-mode input voltage | 5, 7, 9       |
| CMRR        | Common-mode rejection ratio           | vs Frequency                 | 10            |
| $V_{OH}$    | High-level output voltage             | vs High-level output current | 11, 13, 15    |
| $V_{OL}$    | Low-level output voltage              | vs Low-level output current  | 12, 14, 16    |
| $V_{O(PP)}$ | Output voltage peak-to-peak           | vs Frequency                 | 17            |
| $Z_o$       | Output impedance                      | vs Frequency                 | 18            |
| $I_{CC}$    | Supply current                        | vs Supply voltage            | 19            |
| PSRR        | Power supply rejection ratio          | vs Frequency                 | 20            |
| $A_{VD}$    | Differential voltage gain             | vs Frequency                 | 21            |
|             | Phase                                 | vs Frequency                 | 21            |
|             | Gain-bandwidth product                | vs Supply voltage            | 22            |
| SR          | Slew rate                             | vs Free-air temperature      | 23            |
| $\phi_m$    | Phase margin                          | vs Capacitive load           | 24            |
|             | Gain margin                           | vs Capacitive load           | 25            |
|             | Supply current                        | vs Reverse voltage           | 26            |
|             | Voltage noise over a 10 Second Period |                              | 27            |
|             | Large signal follower pulse response  |                              | 28, 29, 30    |
|             | Small signal follower pulse response  |                              | 31            |
|             | Large signal inverting pulse response |                              | 32, 33, 34    |
|             | Small signal inverting pulse response |                              | 35            |
|             | Crosstalk                             | vs Frequency                 | 36            |



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## FAMILY OF 880-nA/Ch RAIL-TO-RAIL INPUT/OUTPUT

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#### TYPICAL CHARACTERISTICS

**INPUT OFFSET VOLTAGE**  
vs  
**COMMON-MODE INPUT**  
**VOLTAGE**



Figure 1

**INPUT OFFSET VOLTAGE**  
vs  
**COMMON-MODE INPUT**  
**VOLTAGE**



Figure 2

**INPUT OFFSET VOLTAGE**  
vs  
**COMMON-MODE INPUT**  
**VOLTAGE**



Figure 3

**INPUT BIAS / OFFSET CURRENT**  
vs  
**FREE-AIR TEMPERATURE**



Figure 4

**INPUT BIAS / OFFSET CURRENT**  
vs  
**COMMON MODE INPUT**  
**VOLTAGE**



Figure 5

**INPUT BIAS / OFFSET CURRENT**  
vs  
**FREE-AIR TEMPERATURE**



Figure 6

**INPUT BIAS / OFFSET CURRENT**  
vs  
**COMMON-MODE INPUT**  
**VOLTAGE**



Figure 7

**INPUT BIAS / OFFSET CURRENT**  
vs  
**FREE-AIR TEMPERATURE**



Figure 8

**INPUT BIAS / OFFSET CURRENT**  
vs  
**COMMON-MODE INPUT**  
**VOLTAGE**



Figure 9



**TYPICAL CHARACTERISTICS**

**COMMON-MODE REJECTION RATIO  
 vs  
 FREQUENCY**

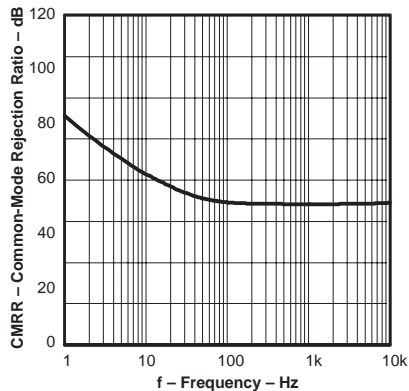


Figure 10

**HIGH-LEVEL OUTPUT VOLTAGE  
 vs  
 HIGH-LEVEL OUTPUT CURRENT**

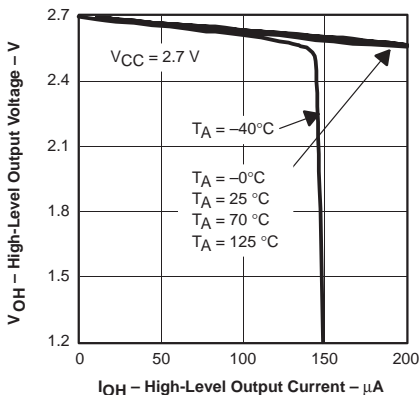


Figure 11

**LOW-LEVEL OUTPUT VOLTAGE  
 vs  
 LOW-LEVEL OUTPUT CURRENT**



Figure 12

**HIGH-LEVEL OUTPUT VOLTAGE  
 vs  
 HIGH-LEVEL OUTPUT CURRENT**

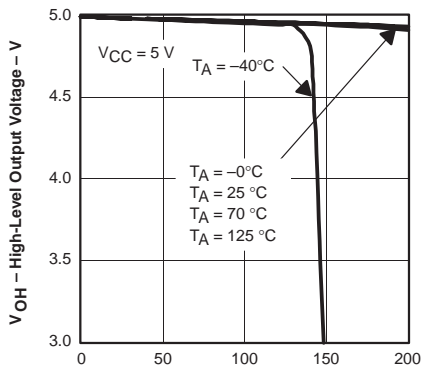


Figure 13

**LOW-LEVEL OUTPUT VOLTAGE  
 vs  
 LOW-LEVEL OUTPUT CURRENT**

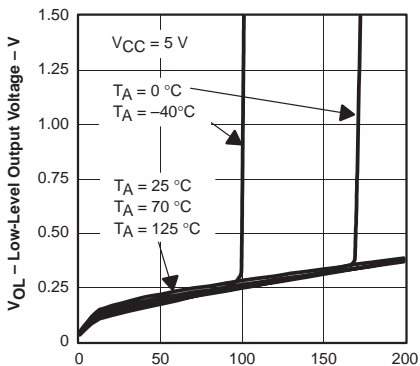


Figure 14

**HIGH-LEVEL OUTPUT VOLTAGE  
 vs  
 HIGH-LEVEL OUTPUT CURRENT**



Figure 15

**LOW-LEVEL OUTPUT VOLTAGE  
 vs  
 LOW-LEVEL OUTPUT CURRENT**

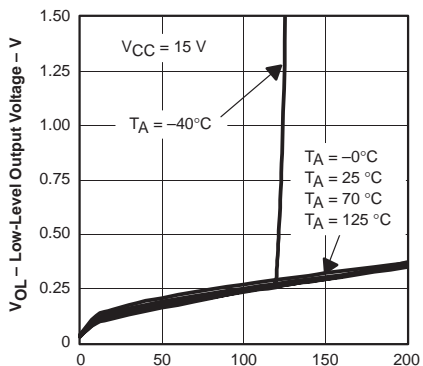


Figure 16

**OUTPUT VOLTAGE  
 PEAK-TO-PEAK  
 vs  
 FREQUENCY**

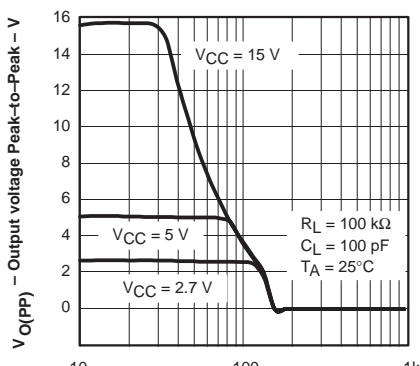


Figure 17

**OUTPUT IMPEDANCE  
 vs  
 FREQUENCY**

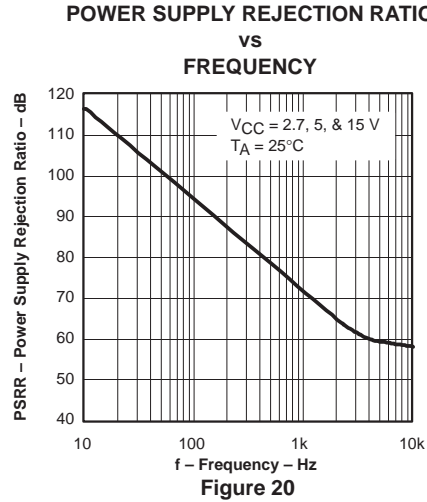


Figure 18

**TLV2401, TLV2402, TLV2404**  
**FAMILY OF 880-nA/Ch RAIL-TO-RAIL INPUT/OUTPUT**  
**OPERATIONAL AMPLIFIERS WITH REVERSE BATTERY PROTECTION**

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**TYPICAL CHARACTERISTICS**

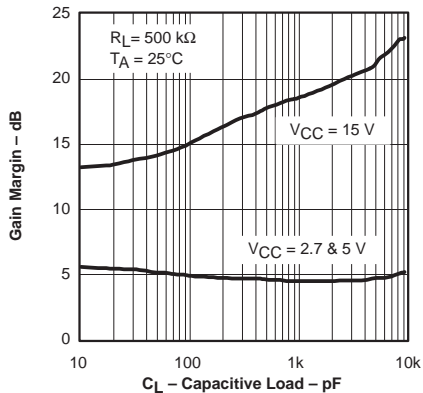


**TLV2401, TLV2402, TLV2404**  
**FAMILY OF 880-nA/Ch RAIL-TO-RAIL INPUT/OUTPUT**  
**OPERATIONAL AMPLIFIERS WITH REVERSE BATTERY PROTECTION**

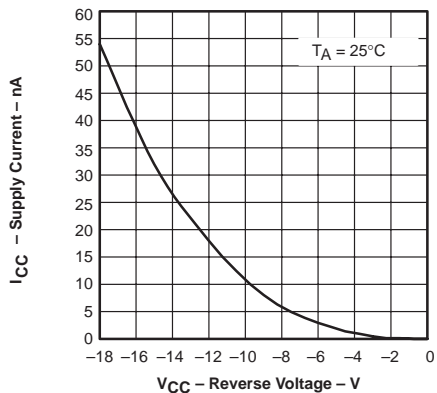
SLOS244B – FEBRUARY 2000 – REVISED NOVEMBER 2000

**TYPICAL CHARACTERISTICS**

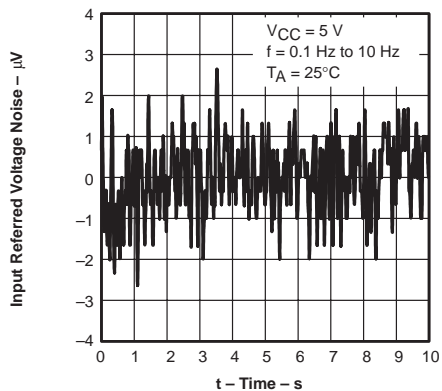
**GAIN MARGIN  
VS  
CAPACITIVE LOAD**



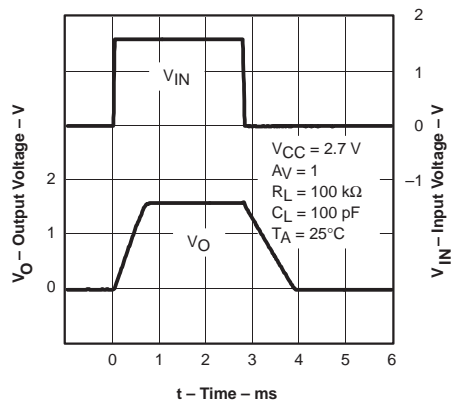
**SUPPLY CURRENT  
VS  
REVERSE VOLTAGE**



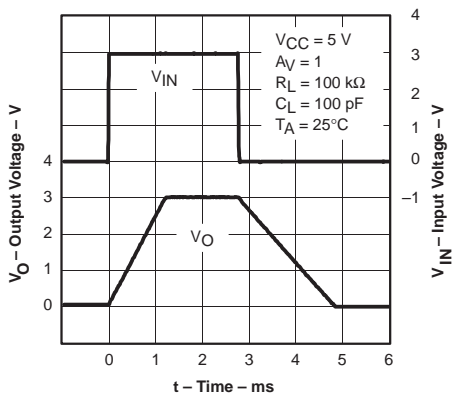
**VOLTAGE NOISE  
OVER A 10 SECOND PERIOD**



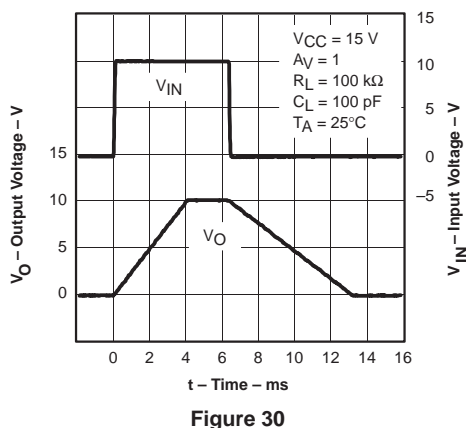
**LARGE SIGNAL FOLLOWER  
PULSE RESPONSE**



**LARGE SIGNAL FOLLOWER  
PULSE RESPONSE**



**LARGE SIGNAL FOLLOWER  
PULSE RESPONSE**



**TLV2401, TLV2402, TLV2404**  
**FAMILY OF 880-nA/Ch RAIL-TO-RAIL INPUT/OUTPUT**  
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**TYPICAL CHARACTERISTICS**

**SMALL SIGNAL FOLLOWER PULSE RESPONSE**



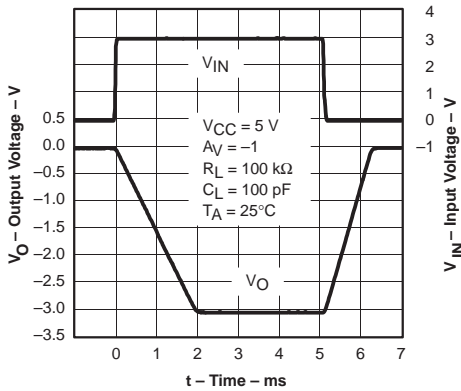
**Figure 31**

**LARGE SIGNAL INVERTING PULSE RESPONSE**



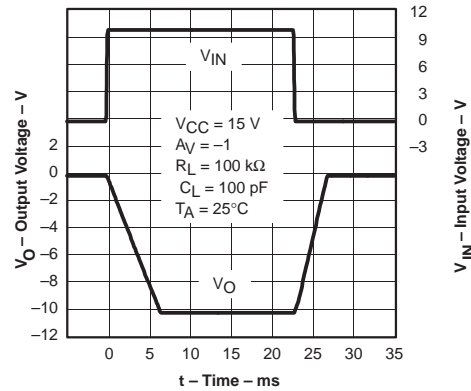
**Figure 32**

**LARGE SIGNAL INVERTING PULSE RESPONSE**



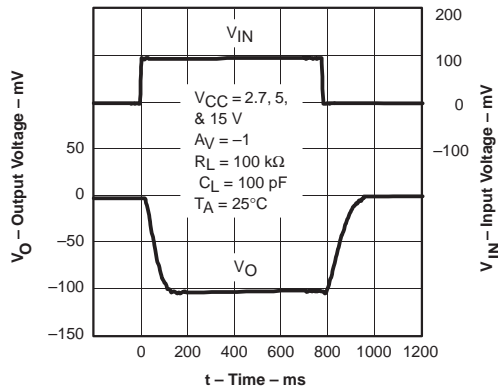
**Figure 33**

**LARGE SIGNAL INVERTING PULSE RESPONSE**



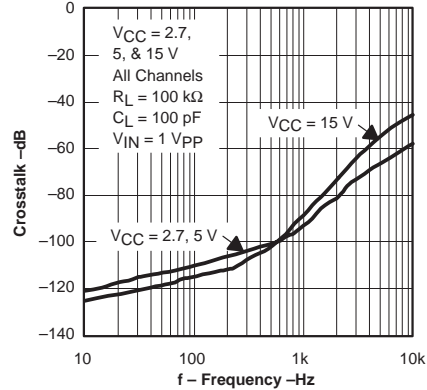
**Figure 34**

**SMALL SIGNAL INVERTING PULSE RESPONSE**



**Figure 35**

**CROSSTALK vs FREQUENCY**



**Figure 36**



## APPLICATION INFORMATION

### reverse battery protection

The TLV2401/2/4 are protected against reverse battery voltage up to 18 V. When subjected to reverse battery condition the supply current is typically less than 100 nA at 25°C (inputs grounded and outputs open). This current is determined by the leakage of 6 Schottky diodes and will therefore increase as the ambient temperature increases.

When subjected to reverse battery conditions and negative voltages applied to the inputs or outputs, the input ESD structure will turn on—this current should be limited to less than 10 mA. If the inputs or outputs are referred to ground, rather than midrail, no extra precautions need be taken.

### common-mode input range

The TLV2401/2/4 has rail-to-rail input and outputs. For common-mode inputs from  $-0.1\text{ V}$  to  $V_{CC} - 0.8\text{ V}$  a PNP differential pair will provide the gain.

For inputs between  $V_{CC} - 0.8\text{ V}$  and  $V_{CC}$ , two NPN emitter followers buffering a second PNP differential pair provide the gain. This special combination of NPN/PNP differential pair enables the inputs to be taken 5 V above the rails, because as the inputs go above  $V_{CC}$ , the NPNs switch from functioning as transistors to functioning as diodes. This will lead to an increase in input bias current. The second PNP differential pair continues to function normally as the inputs exceed  $V_{CC}$ .

The TLV2401/2/4 has a negative common-input range that exceeds ground by 100 mV. If the inputs are taken much below this, reduced open loop gain will be observed with the ultimate possibility of phase inversion.

### offset voltage

The output offset voltage, ( $V_{OO}$ ) is the sum of the input offset voltage ( $V_{IO}$ ) and both input bias currents ( $I_{IB}$ ) times the corresponding gains. The following schematic and formula can be used to calculate the output offset voltage:



**Figure 37. Output Offset Voltage Model**

APPLICATION INFORMATION

general configurations

When receiving low-level signals, limiting the bandwidth of the incoming signals into the system is often required. The simplest way to accomplish this is to place an RC filter at the noninverting terminal of the amplifier (see Figure 38).

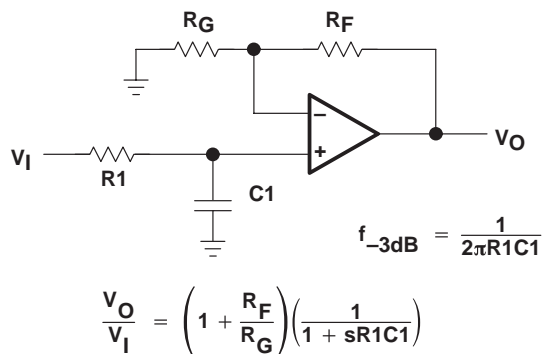


Figure 38. Single-Pole Low-Pass Filter

If even more attenuation is needed, a multiple pole filter is required. The Sallen-Key filter can be used for this task. For best results, the amplifier should have a bandwidth that is 8 to 10 times the filter frequency bandwidth. Failure to do this can result in phase shift of the amplifier.



Figure 39. 2-Pole Low-Pass Sallen-Key Filter

## APPLICATION INFORMATION

### circuit layout considerations

To achieve the levels of high performance of the TLV240x, follow proper printed-circuit board design techniques. A general set of guidelines is given in the following.

- Ground planes – It is highly recommended that a ground plane be used on the board to provide all components with a low inductive ground connection. However, in the areas of the amplifier inputs and output, the ground plane can be removed to minimize the stray capacitance.
- Proper power supply decoupling – Use a 6.8- $\mu$ F tantalum capacitor in parallel with a 0.1- $\mu$ F ceramic capacitor on each supply terminal. It may be possible to share the tantalum among several amplifiers depending on the application, but a 0.1- $\mu$ F ceramic capacitor should always be used on the supply terminal of every amplifier. In addition, the 0.1- $\mu$ F capacitor should be placed as close as possible to the supply terminal. As this distance increases, the inductance in the connecting trace makes the capacitor less effective. The designer should strive for distances of less than 0.1 inches between the device power terminals and the ceramic capacitors.
- Sockets – Sockets can be used but are not recommended. The additional lead inductance in the socket pins will often lead to stability problems. Surface-mount packages soldered directly to the printed-circuit board is the best implementation.
- Short trace runs/compact part placements – Optimum high performance is achieved when stray series inductance has been minimized. To realize this, the circuit layout should be made as compact as possible, thereby minimizing the length of all trace runs. Particular attention should be paid to the inverting input of the amplifier. Its length should be kept as short as possible. This will help to minimize stray capacitance at the input of the amplifier.
- Surface-mount passive components – Using surface-mount passive components is recommended for high performance amplifier circuits for several reasons. First, because of the extremely low lead inductance of surface-mount components, the problem with stray series inductance is greatly reduced. Second, the small size of surface-mount components naturally leads to a more compact layout thereby minimizing both stray inductance and capacitance. If leaded components are used, it is recommended that the lead lengths be kept as short as possible.

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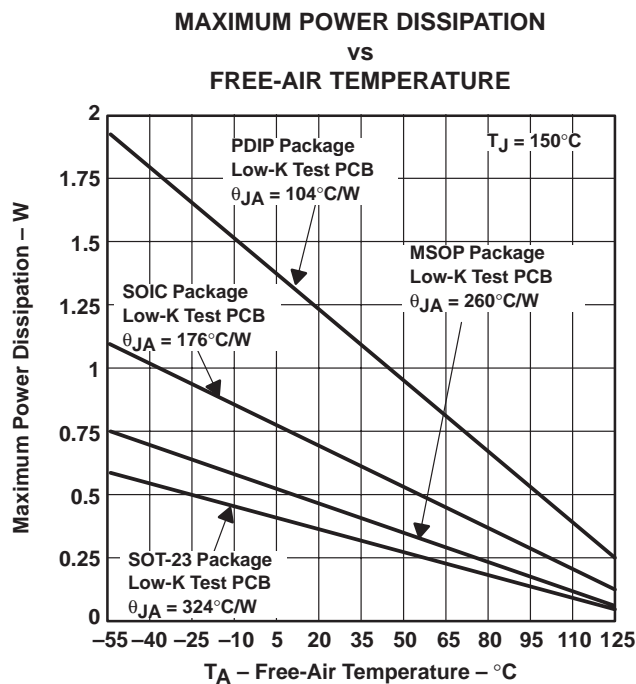
**general power dissipation considerations**

For a given  $\theta_{JA}$ , the maximum power dissipation is shown in Figure 40 and is calculated by the following formula:

$$P_D = \left( \frac{T_{MAX} - T_A}{\theta_{JA}} \right)$$

Where:

- $P_D$  = Maximum power dissipation of THS240x IC (watts)
- $T_{MAX}$  = Absolute maximum junction temperature (150°C)
- $T_A$  = Free-ambient air temperature (°C)
- $\theta_{JA}$  =  $\theta_{JC} + \theta_{CA}$
- $\theta_{JC}$  = Thermal coefficient from junction to case
- $\theta_{CA}$  = Thermal coefficient from case to ambient air (°C/W)



NOTE A: Results are with no air flow and using JEDEC Standard Low-K test PCB.

**Figure 40. Maximum Power Dissipation vs Free-Air Temperature**



**TLV2401, TLV2402, TLV2404**  
**FAMILY OF 880-nA/Ch RAIL-TO-RAIL INPUT/OUTPUT**  
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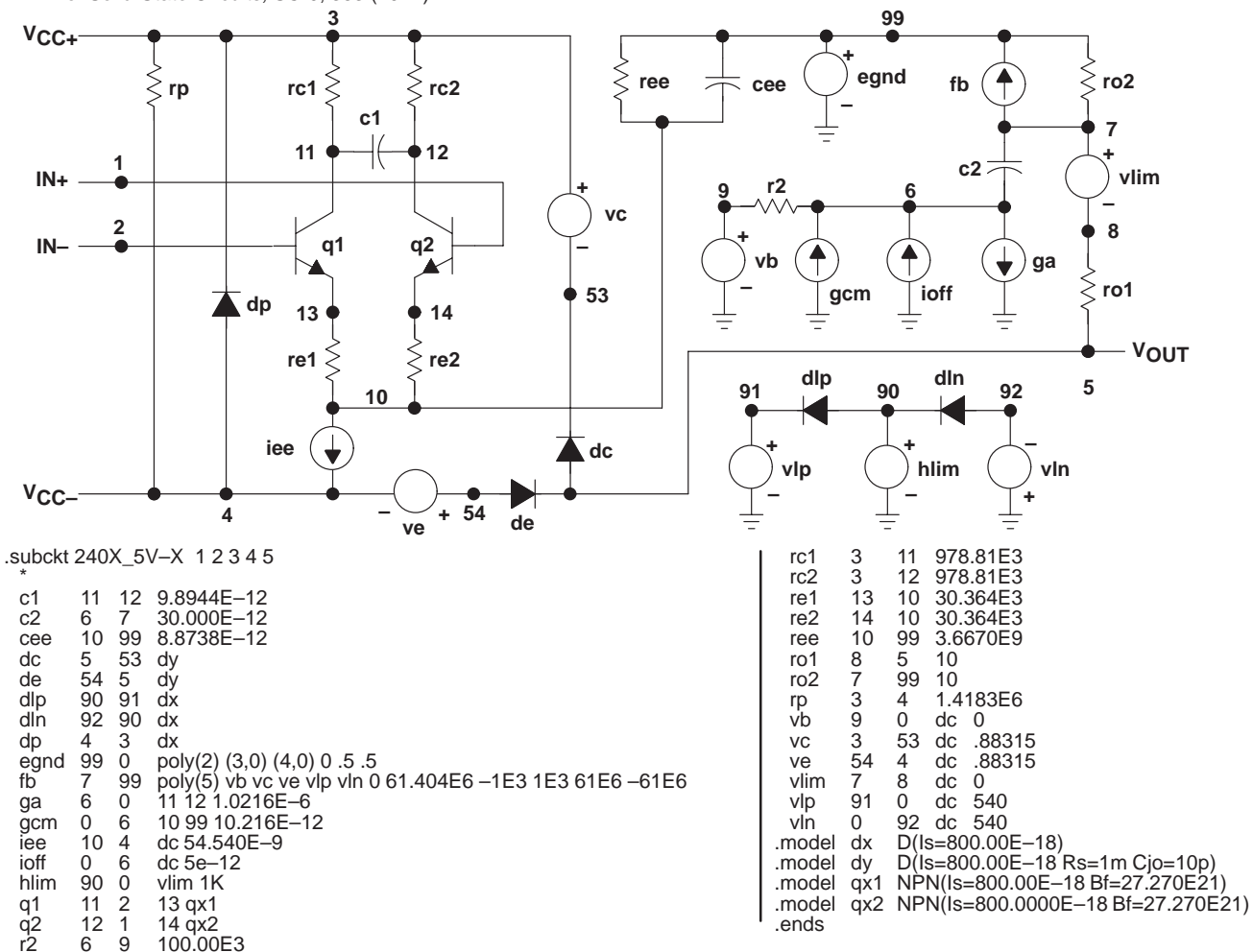
**APPLICATION INFORMATION**

**macromodel information**

Macromodel information provided was derived using Microsim *Parts*™ Release 8, the model generation software used with Microsim *PSpice*™. The Boyle macromodel (see Note 2) and subcircuit in Figure 41 are generated using the TLV240x typical electrical and operating characteristics at  $T_A = 25^\circ\text{C}$ . Using this information, output simulations of the following key parameters can be generated to a tolerance of 20% (in most cases):

- Maximum positive output voltage swing
- Maximum negative output voltage swing
- Slew rate
- Quiescent power dissipation
- Input bias current
- Open-loop voltage amplification
- Unity-gain frequency
- Common-mode rejection ratio
- Phase margin
- DC output resistance
- AC output resistance
- Short-circuit output current limit

NOTE 2: G. R. Boyle, B. M. Cohn, D. O. Pederson, and J. E. Solomon, "Macromodeling of Integrated Circuit Operational Amplifiers", *IEEE Journal of Solid-State Circuits*, SC-9, 353 (1974).



**Figure 41. Boyle Macromodels and Subcircuit**

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**PACKAGING INFORMATION**

| Orderable part number          | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|--------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">TLV2401CD</a>      | Obsolete      | Production           | SOIC (D)   8     | -                     | -           | Call TI                              | Call TI                           | 0 to 70      | 2401C               |
| <a href="#">TLV2401CDBVR</a>   | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | 0 to 70      | VAWC                |
| <a href="#">TLV2401CDBVR.A</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | VAWC                |
| <a href="#">TLV2401CDBVT</a>   | Active        | Production           | SOT-23 (DBV)   5 | 250   SMALL T&R       | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | 0 to 70      | VAWC                |
| <a href="#">TLV2401CDBVT.A</a> | Active        | Production           | SOT-23 (DBV)   5 | 250   SMALL T&R       | Yes         | SN                                   | Level-1-260C-UNLIM                | 0 to 70      | VAWC                |
| <a href="#">TLV2401CDR</a>     | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 2401C               |
| <a href="#">TLV2401CDR.A</a>   | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 2401C               |
| <a href="#">TLV2401ID</a>      | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 2401I               |
| <a href="#">TLV2401ID.A</a>    | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 2401I               |
| <a href="#">TLV2401IDBVR</a>   | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | VAWI                |
| <a href="#">TLV2401IDBVR.A</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | VAWI                |
| <a href="#">TLV2401IDBVT</a>   | Active        | Production           | SOT-23 (DBV)   5 | 250   SMALL T&R       | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | VAWI                |
| <a href="#">TLV2401IDBVT.A</a> | Active        | Production           | SOT-23 (DBV)   5 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | VAWI                |
| <a href="#">TLV2401IDBVTG4</a> | Active        | Production           | SOT-23 (DBV)   5 | 250   SMALL T&R       | -           | Call TI                              | Call TI                           | -40 to 125   |                     |
| <a href="#">TLV2401IDR</a>     | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 2401I               |
| <a href="#">TLV2401IDR.A</a>   | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 2401I               |
| <a href="#">TLV2401IP</a>      | Active        | Production           | PDIP (P)   8     | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 125   | TLV2401I            |
| <a href="#">TLV2401IP.A</a>    | Active        | Production           | PDIP (P)   8     | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 125   | TLV2401I            |
| <a href="#">TLV2402CD</a>      | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 2402C               |
| <a href="#">TLV2402CD.A</a>    | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 2402C               |
| <a href="#">TLV2402CDGK</a>    | Active        | Production           | VSSOP (DGK)   8  | 80   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | AIX                 |
| <a href="#">TLV2402CDGK.A</a>  | Active        | Production           | VSSOP (DGK)   8  | 80   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | AIX                 |
| <a href="#">TLV2402CDGKR</a>   | Active        | Production           | VSSOP (DGK)   8  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | AIX                 |
| <a href="#">TLV2402CDGKR.A</a> | Active        | Production           | VSSOP (DGK)   8  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | AIX                 |
| <a href="#">TLV2402CDR</a>     | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 2402C               |
| <a href="#">TLV2402CDR.A</a>   | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 2402C               |
| <a href="#">TLV2402ID</a>      | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 2402I               |
| <a href="#">TLV2402ID.A</a>    | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 2402I               |
| <a href="#">TLV2402IDGK</a>    | Active        | Production           | VSSOP (DGK)   8  | 80   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | AIY                 |

| Orderable part number        | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| TLV2402IDGK.A                | Active        | Production           | VSSOP (DGK)   8 | 80   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | AIY                 |
| <a href="#">TLV2402IDGKR</a> | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | AIY                 |
| TLV2402IDGKR.A               | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | AIY                 |
| <a href="#">TLV2402IDR</a>   | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 2402I               |
| TLV2402IDR.A                 | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 2402I               |
| <a href="#">TLV2402IP</a>    | Active        | Production           | PDIP (P)   8    | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 125   | TLV2402I            |
| TLV2402IP.A                  | Active        | Production           | PDIP (P)   8    | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 125   | TLV2402I            |
| <a href="#">TLV2404CD</a>    | Active        | Production           | SOIC (D)   14   | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | TLV2404C            |
| TLV2404CD.A                  | Active        | Production           | SOIC (D)   14   | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | TLV2404C            |
| <a href="#">TLV2404CPW</a>   | Active        | Production           | TSSOP (PW)   14 | 90   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 2404C               |
| TLV2404CPW.A                 | Active        | Production           | TSSOP (PW)   14 | 90   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 2404C               |
| <a href="#">TLV2404CPWR</a>  | Active        | Production           | TSSOP (PW)   14 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 2404C               |
| TLV2404CPWR.A                | Active        | Production           | TSSOP (PW)   14 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 2404C               |
| <a href="#">TLV2404ID</a>    | Active        | Production           | SOIC (D)   14   | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | TLV2404I            |
| TLV2404ID.A                  | Active        | Production           | SOIC (D)   14   | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | TLV2404I            |
| <a href="#">TLV2404IDR</a>   | Active        | Production           | SOIC (D)   14   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | TLV2404I            |
| TLV2404IDR.A                 | Active        | Production           | SOIC (D)   14   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | TLV2404I            |
| <a href="#">TLV2404IN</a>    | Active        | Production           | PDIP (N)   14   | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 125   | TLV2404IN           |
| TLV2404IN.A                  | Active        | Production           | PDIP (N)   14   | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 125   | TLV2404IN           |
| <a href="#">TLV2404IPW</a>   | Active        | Production           | TSSOP (PW)   14 | 90   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 2404I               |
| TLV2404IPW.A                 | Active        | Production           | TSSOP (PW)   14 | 90   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 2404I               |
| <a href="#">TLV2404IPWR</a>  | Active        | Production           | TSSOP (PW)   14 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 2404I               |
| TLV2404IPWR.A                | Active        | Production           | TSSOP (PW)   14 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 2404I               |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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**OTHER QUALIFIED VERSIONS OF TLV2401, TLV2402 :**

- Automotive : [TLV2401-Q1](#), [TLV2402-Q1](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**

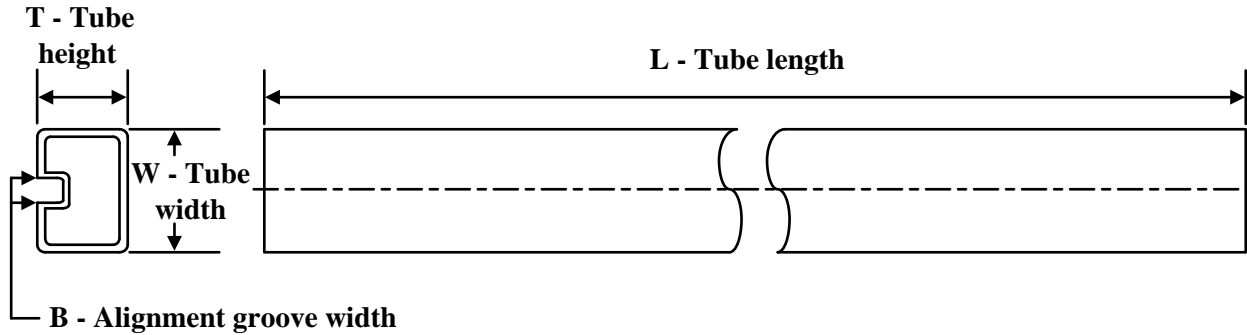

\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TLV2401CDBVR | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TLV2401CDBVT | SOT-23       | DBV             | 5    | 250  | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TLV2401CDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TLV2401IDBVR | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TLV2401IDBVT | SOT-23       | DBV             | 5    | 250  | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TLV2401IDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TLV2402CDGKR | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| TLV2402CDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TLV2402IDGKR | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| TLV2402IDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TLV2404CPWR  | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| TLV2404IDR   | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| TLV2404IPWR  | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TLV2401CDBVR | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| TLV2401CDBVT | SOT-23       | DBV             | 5    | 250  | 210.0       | 185.0      | 35.0        |
| TLV2401CDR   | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| TLV2401IDBVR | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| TLV2401IDBVT | SOT-23       | DBV             | 5    | 250  | 210.0       | 185.0      | 35.0        |
| TLV2401IDR   | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| TLV2402CDGKR | VSSOP        | DGK             | 8    | 2500 | 358.0       | 335.0      | 35.0        |
| TLV2402CDR   | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| TLV2402IDGKR | VSSOP        | DGK             | 8    | 2500 | 358.0       | 335.0      | 35.0        |
| TLV2402IDR   | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| TLV2404CPWR  | TSSOP        | PW              | 14   | 2000 | 353.0       | 353.0      | 32.0        |
| TLV2404IDR   | SOIC         | D               | 14   | 2500 | 350.0       | 350.0      | 43.0        |
| TLV2404IPWR  | TSSOP        | PW              | 14   | 2000 | 353.0       | 353.0      | 32.0        |

**TUBE**


\*All dimensions are nominal

| Device       | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|--------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| TLV2401ID    | D            | SOIC         | 8    | 75  | 505.46 | 6.76   | 3810   | 4      |
| TLV2401ID    | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLV2401ID.A  | D            | SOIC         | 8    | 75  | 505.46 | 6.76   | 3810   | 4      |
| TLV2401ID.A  | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLV2401IP    | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TLV2401IP.A  | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TLV2402CD    | D            | SOIC         | 8    | 75  | 505.46 | 6.76   | 3810   | 4      |
| TLV2402CD    | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLV2402CD.A  | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLV2402CD.A  | D            | SOIC         | 8    | 75  | 505.46 | 6.76   | 3810   | 4      |
| TLV2402ID    | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLV2402ID.A  | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLV2402IP    | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TLV2402IP.A  | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TLV2404CD    | D            | SOIC         | 14   | 50  | 505.46 | 6.76   | 3810   | 4      |
| TLV2404CD.A  | D            | SOIC         | 14   | 50  | 505.46 | 6.76   | 3810   | 4      |
| TLV2404CPW   | PW           | TSSOP        | 14   | 90  | 530    | 10.2   | 3600   | 3.5    |
| TLV2404CPW.A | PW           | TSSOP        | 14   | 90  | 530    | 10.2   | 3600   | 3.5    |
| TLV2404ID    | D            | SOIC         | 14   | 50  | 505.46 | 6.76   | 3810   | 4      |
| TLV2404ID.A  | D            | SOIC         | 14   | 50  | 505.46 | 6.76   | 3810   | 4      |
| TLV2404IN    | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TLV2404IN.A  | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TLV2404IPW   | PW           | TSSOP        | 14   | 90  | 530    | 10.2   | 3600   | 3.5    |
| TLV2404IPW.A | PW           | TSSOP        | 14   | 90  | 530    | 10.2   | 3600   | 3.5    |



D0008A

# PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

NOTES:

- Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
- This drawing is subject to change without notice.
- This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- This dimension does not include interlead flash.
- Reference JEDEC registration MS-012, variation AA.

# EXAMPLE BOARD LAYOUT

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
 EXPOSED METAL SHOWN  
 SCALE:8X



SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON .005 INCH [0.125 MM] THICK STENCIL  
SCALE:8X

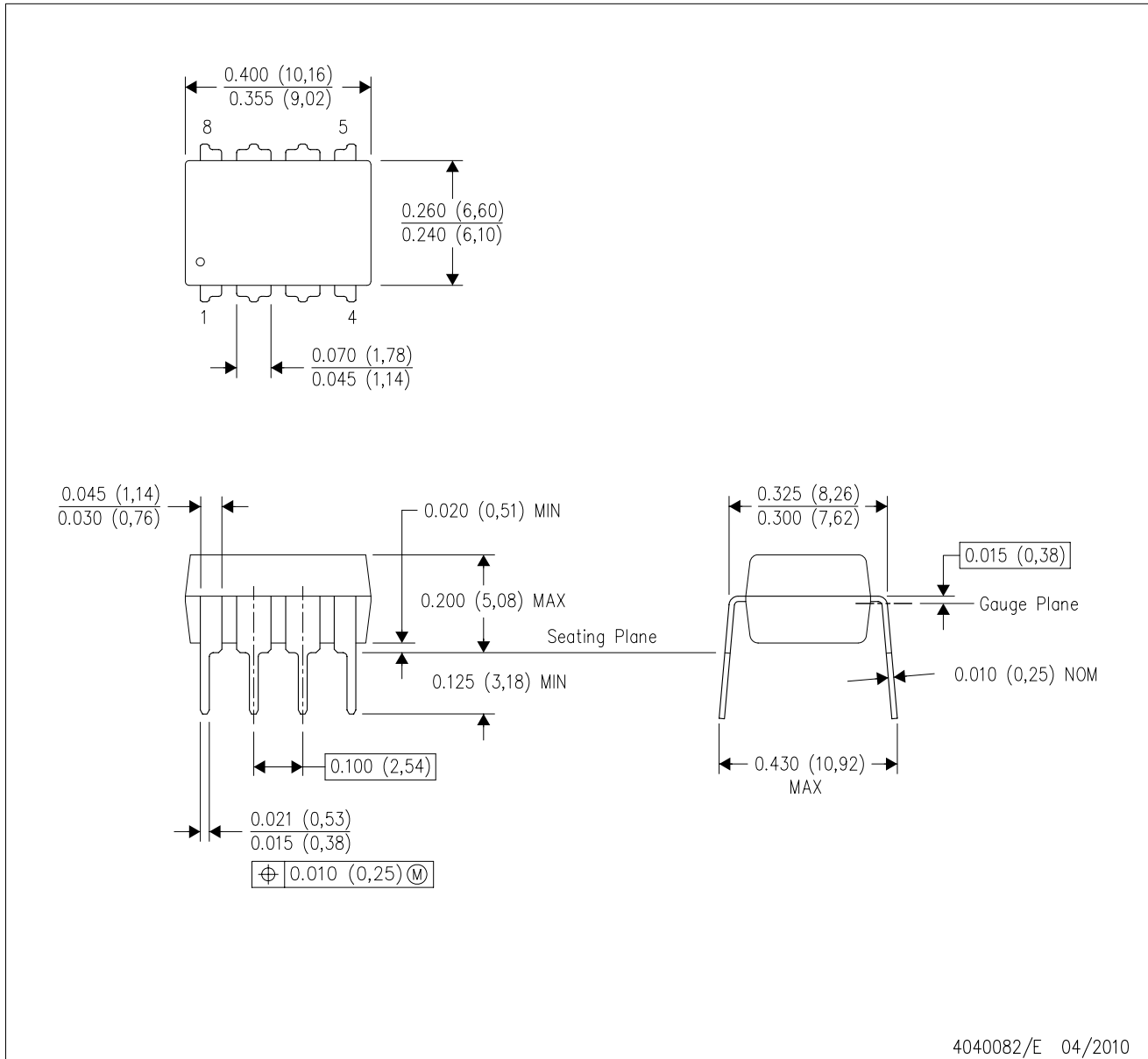
4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-001 variation BA.

N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



4040049/E 12/2002

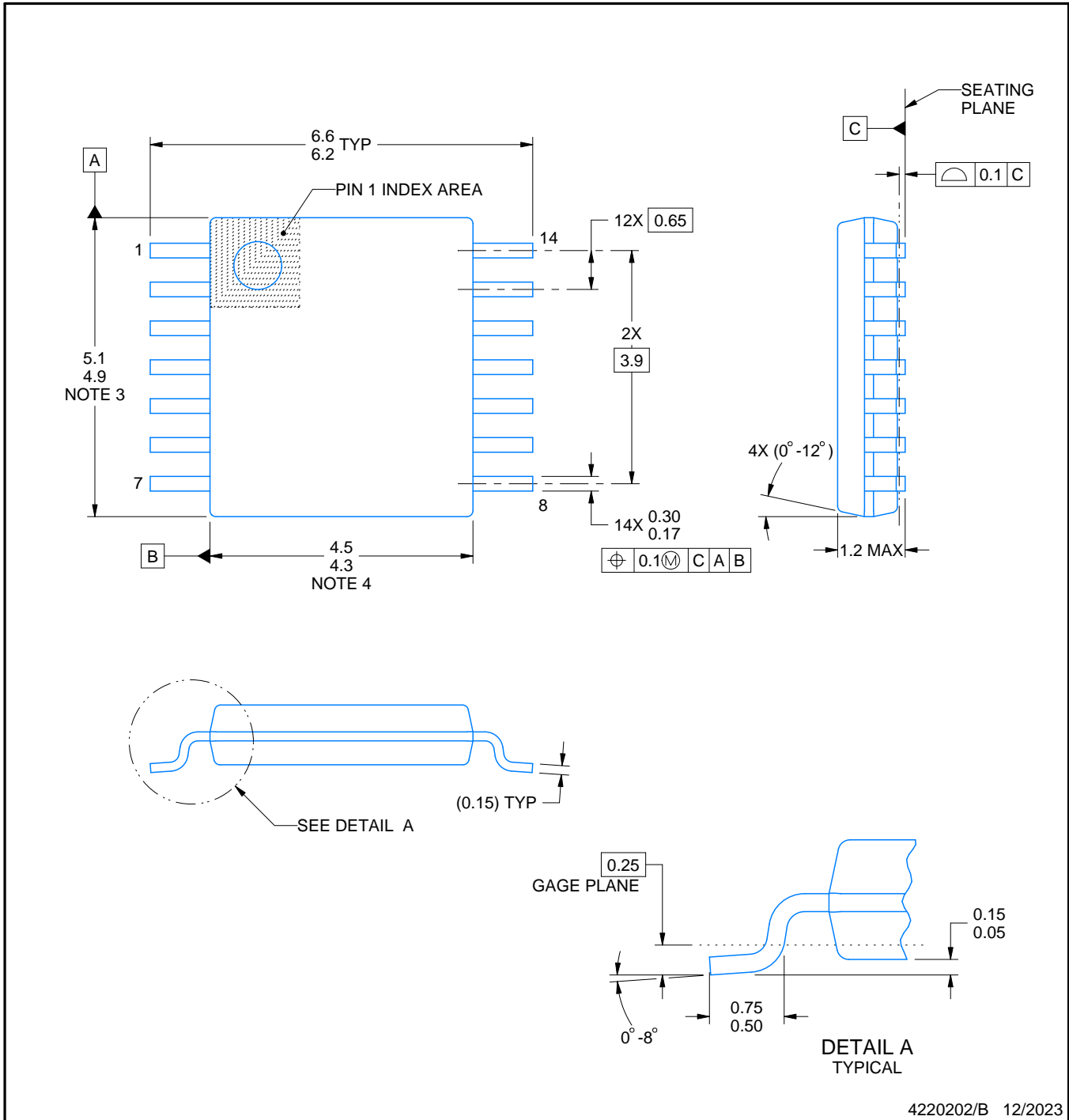
- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - (C) Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - (D) The 20 pin end lead shoulder width is a vendor option, either half or full width.

PW0014A



**PACKAGE OUTLINE**  
**TSSOP - 1.2 mm max height**

SMALL OUTLINE PACKAGE



4220202/B 12/2023

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

PW0014A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



4220202/B 12/2023

NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

PW0014A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220202/B 12/2023

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.



# D0014A

# PACKAGE OUTLINE

## SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



4220718/A 09/2016

### NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
5. Reference JEDEC registration MS-012, variation AB.

# EXAMPLE BOARD LAYOUT

D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
SCALE:8X



SOLDER MASK DETAILS

4220718/A 09/2016

NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:8X

4220718/A 09/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.



# EXAMPLE BOARD LAYOUT

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

4214839/K 08/2024

NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



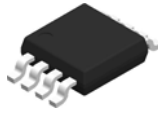
SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

4214839/K 08/2024

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

DGK0008A



# PACKAGE OUTLINE

VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



4214862/A 04/2023

PowerPAD is a trademark of Texas Instruments.

## NOTES:

- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- This drawing is subject to change without notice.
- This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
- This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- Reference JEDEC registration MO-187.

# EXAMPLE BOARD LAYOUT

DGK0008A

™ VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 15X



4214862/A 04/2023

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
8. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.
9. Size of metal pad may vary due to creepage requirement.

# EXAMPLE STENCIL DESIGN

DGK0008A

™ VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
SCALE: 15X

4214862/A 04/2023

NOTES: (continued)

11. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
12. Board assembly site may have different recommendations for stencil design.

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